



**THE DATASHEET OF  
MBRB3030CTG**



# MBRB3030CT

Preferred Device

## SWITCHMODE™ Power Rectifier

These state-of-the-art devices use the Schottky Barrier principle with a proprietary barrier metal.

### Features

- Guardring for Stress Protection
- Maximum Die Size
- 175°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured – Not Sheared
- Pb-Free Packages are Available

### Mechanical Characteristics:

- Case: Epoxy, Molded, Epoxy Meets UL 94 V-0
- Weight: 1.7 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL1 Requirements
- ESD Ratings: Machine Model, C (>400 V)  
Human Body Model, 3B (>8000 V)

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	30	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 134^\circ\text{C}$ ) Per Device Per Leg	$I_{F(AV)}$	30 15	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz, $T_C = +137^\circ\text{C}$ ) Per Leg	$I_{FRM}$	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions, Halfwave, Single Phase, 60 Hz)	$I_{FSM}$	200	A
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	A
Storage Temperature Range	$T_{stg}$	-55 to +175	°C
Operating Junction Temperature (Note 1)	$T_J$	-55 to +175	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/ $\mu\text{s}$
Reverse Energy (Unclamped Inductive Surge) (Inductance = 3 mH, $T_C = 25^\circ\text{C}$ )	W	100	mJ

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

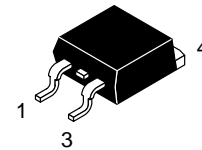
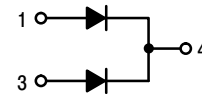
1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .



ON Semiconductor®

<http://onsemi.com>

## SCHOTTKY BARRIER RECTIFIER 30 AMPERES, 30 VOLTS



D<sup>2</sup>PAK  
CASE 418B  
STYLE 3

### MARKING DIAGRAM



A = Assembly Location  
Y = Year  
WW = Work Week  
B3030CT = Device Code  
G = Pb-Free Package  
AKA = Diode Polarity

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

# MBRB3030CT

## THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance, – Junction-to-Case – Junction-to-Ambient (Note 2)	$R_{\theta JC}$ $R_{\theta JA}$	1.0 50	$^{\circ}C/W$

2. When mounted using minimum recommended pad size on FR-4 board.

## ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 3), Per Leg ( $I_F = 15$ Amps, $T_C = +25^{\circ}C$ ) ( $I_F = 15$ Amps, $T_C = +150^{\circ}C$ ) ( $I_F = 30$ Amps, $T_C = +25^{\circ}C$ ) ( $I_F = 30$ Amps, $T_C = +150^{\circ}C$ )	$V_F$	0.54 0.47 0.67 0.66	V
Maximum Instantaneous Reverse Current (Note 3), Per Leg (Rated dc Voltage, $T_C = +25^{\circ}C$ ) (Reverse Voltage = 10 V, $T_C = +150^{\circ}C$ ) (Rated dc Voltage, $T_C = +150^{\circ}C$ )	$I_R$	0.6 46 145	mA

3. Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle  $\leq 2.0\%$ .

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MBRB3030CT	D <sup>2</sup> PAK	50 Units / Rail
MBRB3030CTG	D <sup>2</sup> PAK (Pb-Free)	50 Units / Rail
MBRB3030CTT4	D <sup>2</sup> PAK	800 Units / Tape & Reel
MBRB3030CTT4G	D <sup>2</sup> PAK (Pb-Free)	800 Units / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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## ELECTRICAL CHARACTERISTICS

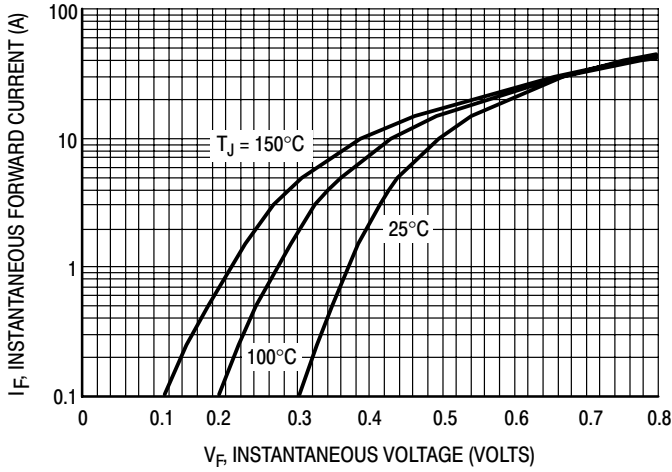


Figure 1. Maximum Forward Voltage, Per Leg

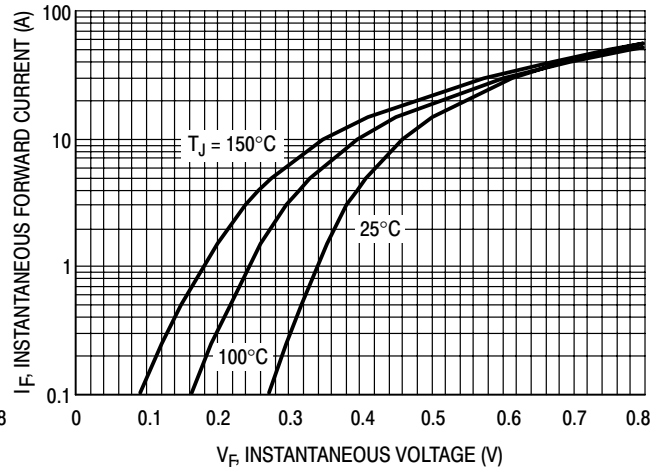


Figure 2. Typical Forward Voltage, Per Leg

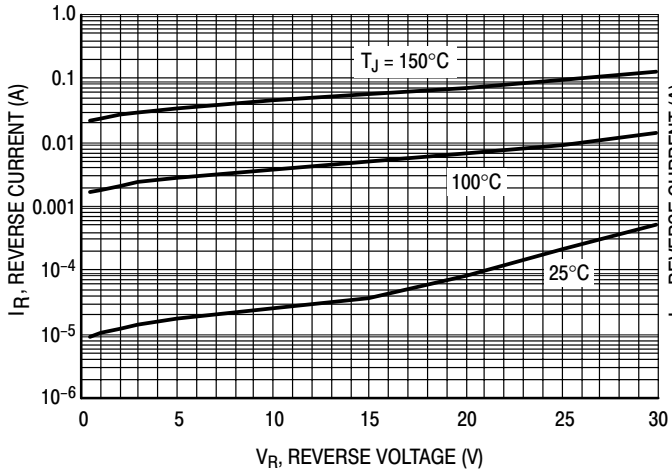


Figure 3. Maximum Reverse Current, Per Leg

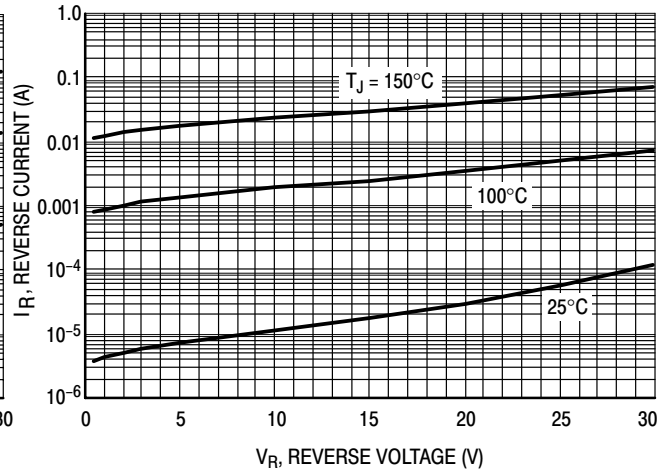


Figure 4. Typical Reverse Current, Per Leg

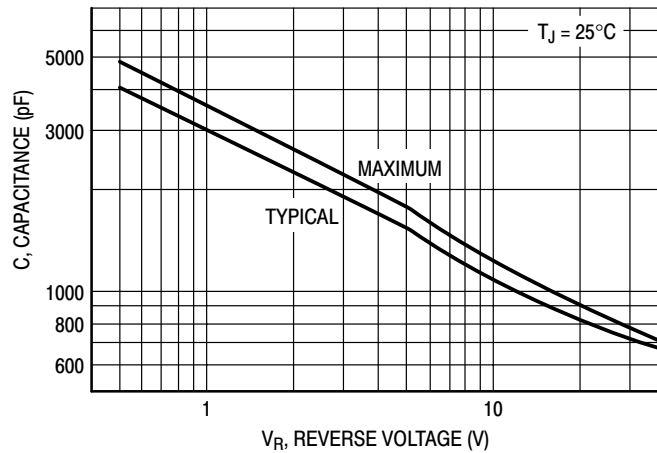


Figure 5. Capacitance

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## TYPICAL CHARACTERISTICS

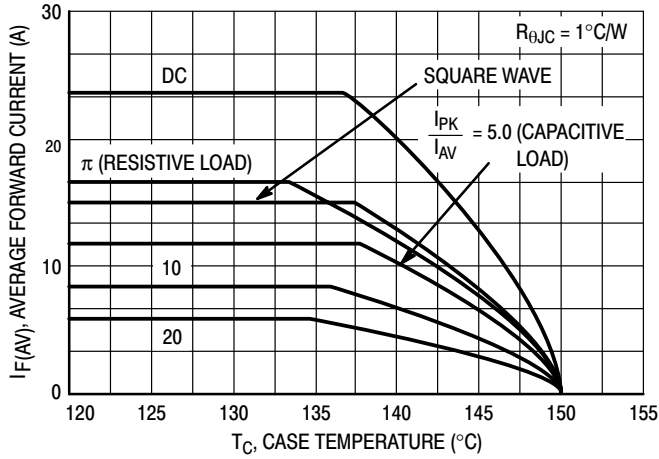


Figure 6. Current Derating, Infinite Heatsink

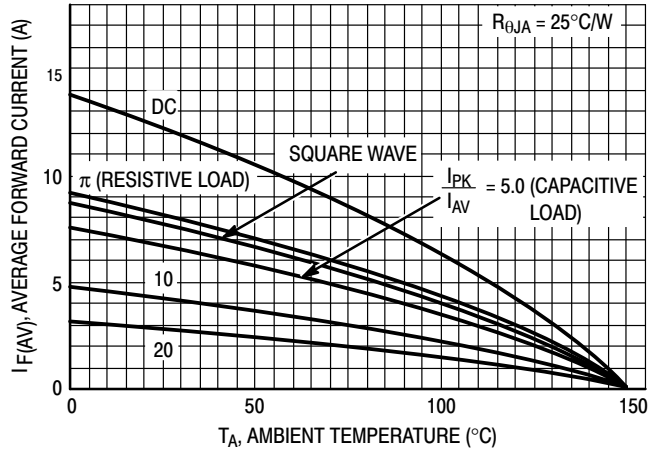


Figure 7. Current Derating

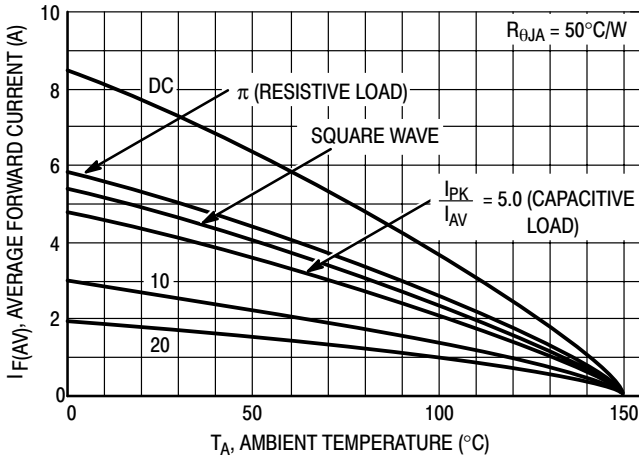


Figure 8. Current Derating, Free Air

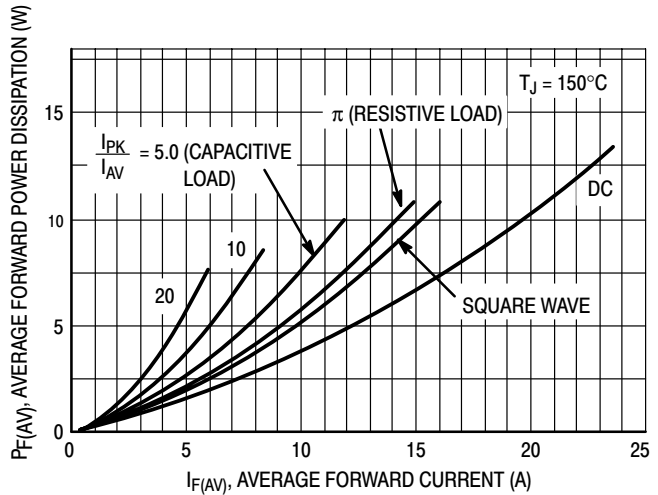


Figure 9. Forward Power Dissipation

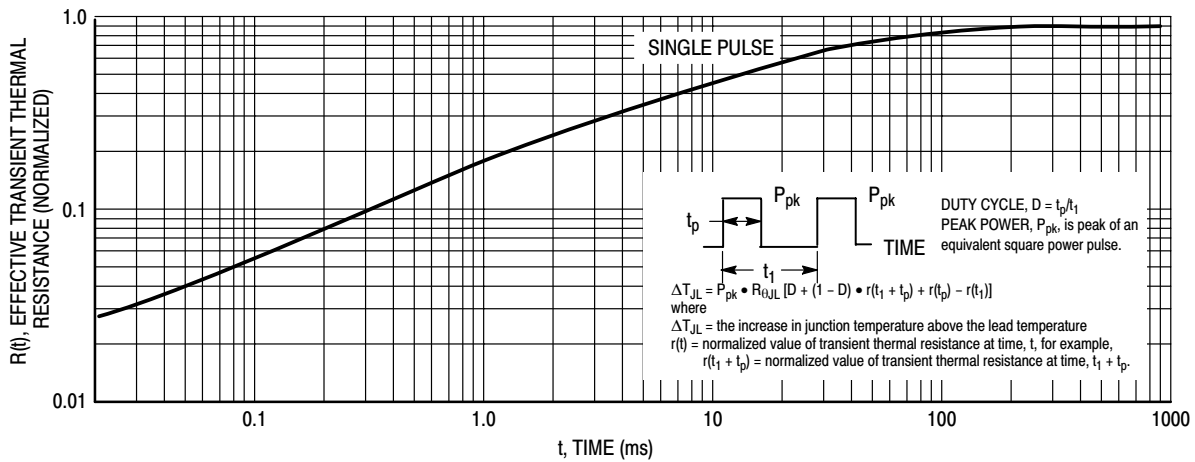
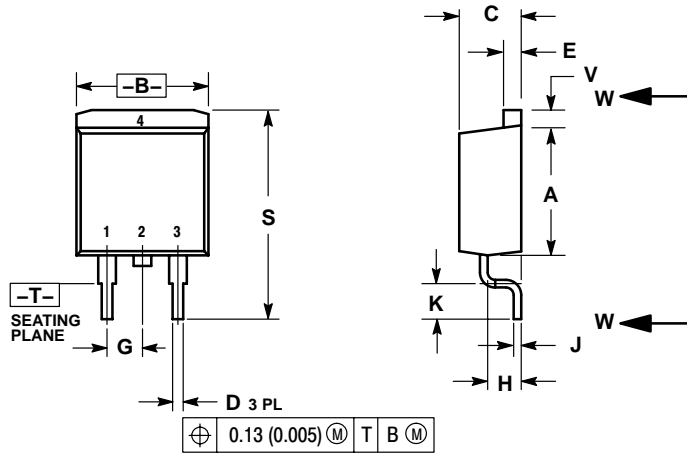


Figure 10. Thermal Response

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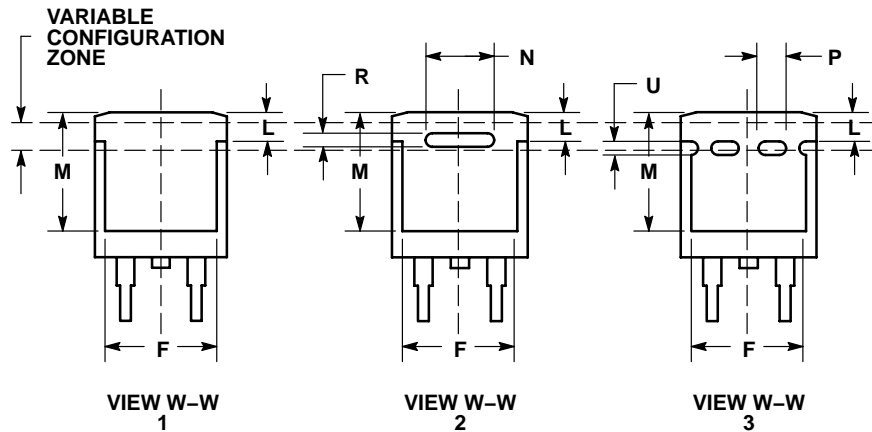
## PACKAGE DIMENSIONS

**D<sup>2</sup>PAK 3**  
CASE 418B-04  
ISSUE J



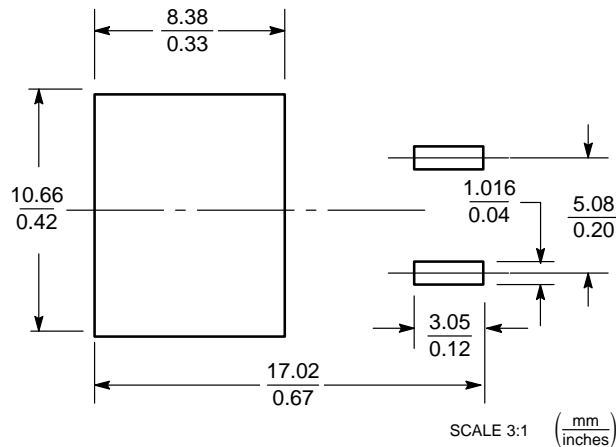
- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.  
3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100	BSC	2.54	BSC
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
M	0.280	0.320	7.11	8.13
N	0.197	REF	5.00	REF
P	0.079	REF	2.00	REF
R	0.039	REF	0.99	REF
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40



- STYLE 3:  
PIN 1. ANODE  
2. CATHODE  
3. ANODE  
4. CATHODE


### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**Phone:** 81-3-5773-3850

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